



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
001/	2Ω @ V _{GS} = 4.5V	000 4
60V	2.5Ω @ V _{GS} = 2.5V	320mA

Description

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Motor Control
- Power Management Functions

Mechanical Data

Case: SOT523

Features

Low On-Resistance: R_{DS(ON)} Low Gate Threshold Voltage Low Input Capacitance Fast Switching Speed Low Input/Output Leakage ESD Protected Up To 1kV

Case Material: Molded Plastic, "Green" Molding Compound.
UL Flammability Classification Rating 94V-0

https://www.diodes.com/quality/product-definitions/

Moisture Sensitivity: Level 1 per J-STD-020

us or your local Diodes representative.

 Terminals: Finish — Matte Tin Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208 (3)

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3)

For automotive applications requiring specific change control

manufactured in IATF 16949 certified facilities), please contact

(i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and

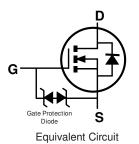
- Terminal Connections: See Diagram
- Weight: 0.002 grams (Approximate)

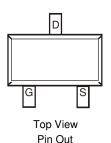




SOT523

Top View





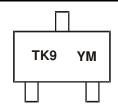
Ordering Information (Note 4)

Part Number	Case	Packaging		
DMN62D0UT-7	SOT523	3,000/Tape & Reel		
DMN62D0UT-13	SOT523	10,000/Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



TK9 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Year	2015		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	С		Н		J	K	L	М	N	0	Р	R
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ $T_A = +25^{\circ}C$ unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	60	V		
Gate-Source Voltage	V_{GSS}	±20	V		
Continuous Drain Current (Note 6) $V_{GS} = 4.5V$ Steady $T_{A} = +25^{\circ}C$ State $T_{A} = +70^{\circ}C$			lo	320 260	mA
Maximum Continuous Body Diode Forward Currer	nt (Note 6)	Is	320	mA	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 19	%)	I _{DM}	1.2	Α	

Thermal Characteristics (@TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	230	mW
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	546	°C/W
Total Power Dissipation (Note 6)		PD	340	mW
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	377	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	60	_	_	V	$V_{GS} = 0V$, $I_D = 10\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1.0	μΑ	$V_{DS} = 60V, V_{GS} = 0V$
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 20V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.5	_	1.0	V	$V_{DS} = 10V, I_D = 250\mu A$
			1.2	2.0		$V_{GS} = 4.5V, I_D = 0.1A$
Static Drain-Source On-Resistance	RDS(ON)	_	1.4	2.5	Ω	$V_{GS} = 2.5V, I_D = 0.05A$
			1.8	3.0		$V_{GS} = 1.8V, I_{D} = 0.05A$
Forward Transconductance	Y _{fs}	_	1.8	_	S	$V_{DS} = 10V, I_D = 0.2A$
Diode Forward Voltage	V _{SD}	_	8.0	1.3	V	V _{GS} = 0V, I _S = 115mA
DYNAMIC CHARACTERISTICS (Note 8)	•					
Input Capacitance	Ciss	_	32	_	рF	
Output Capacitance	Coss	_	3.9	_	рF	V _{DS} = 30V, V _{GS} = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	2.4	_	pF	1 = 1.01011 12
Gate Resistance	Rg	_	101	_	Ω	$f = 1MHz$, $V_{GS} = 0V$, $V_{DS} = 0V$
Total Gate Charge	Qg	_	0.5	_	nC	V 45V V 40V
Gate-Source Charge	Qgs	_	0.09	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Drain Charge	Qgd	_	0.09	_	nC	I _D = 250mA
Turn-On Delay Time	t _{D(ON)}	_	2.4	_	ns	
Turn-On Rise Time	tR	_	2.5	_	ns	V _{DD} = 30V, V _{GS} = 10V,
Turn-Off Delay Time	t _{D(OFF)}	_	22.6	_	ns	$R_G = 25\Omega, I_D = 200 \text{mA}$
Turn-Off Fall Time	t _F	_	12.5	_	ns	

- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
- 6. Device mounted on 1" \times 1" FR-4 PCB with high coverage 2oz. Copper, single sided.
- 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.



DMN62D0UT

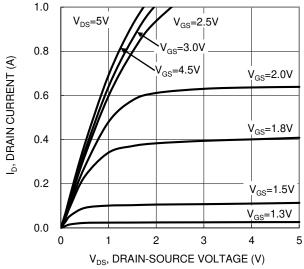


Figure 1. Typical Output Characteristic

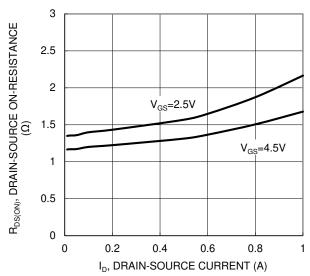


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

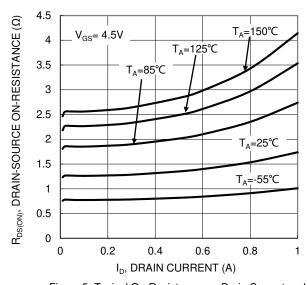


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

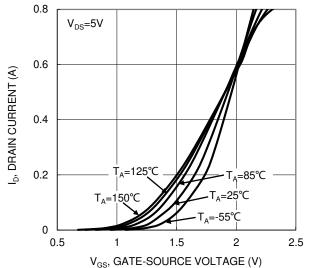


Figure 2. Typical Transfer Characteristic

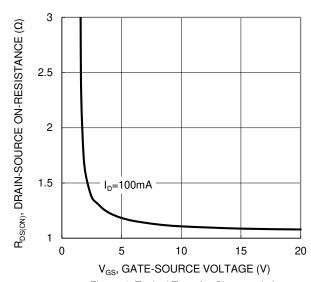


Figure 4. Typical Transfer Characteristic

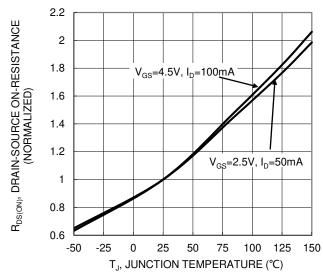


Figure 6. On-Resistance Variation with Junction Temperature



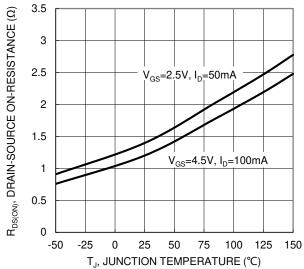


Figure 7. On-Resistance Variation with Junction Temperature

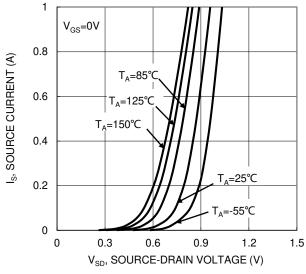


Figure 9. Diode Forward Voltage vs. Current

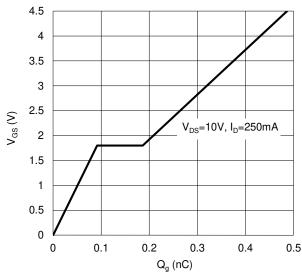


Figure 11. Gate Charge

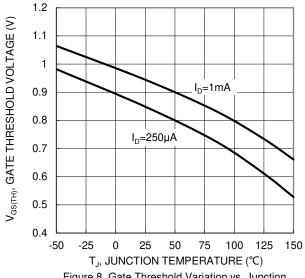


Figure 8. Gate Threshold Variation vs. Junction Temperature

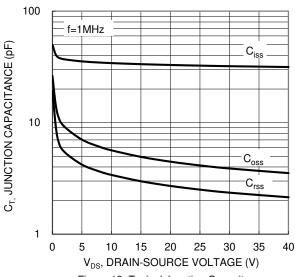


Figure 10. Typical Junction Capacitance

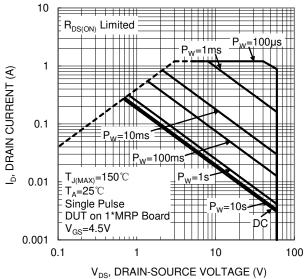


Figure 12. SOA, Safe Operation Area



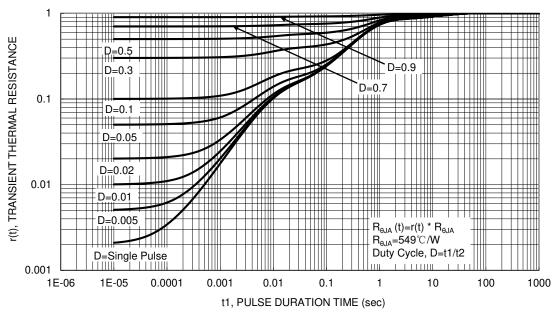


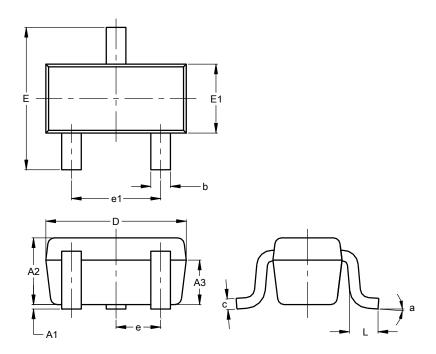
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT523

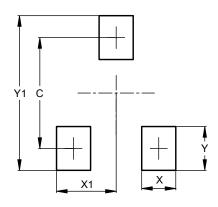


	SOT523						
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.60	0.80	0.75				
A3	0.45	0.65	0.50				
b	0.15	0.30	0.22				
С	0.10	0.20	0.12				
D	1.50	1.70	1.60				
E	1.45	1.75	1.60				
E1	0.75	0.85	0.80				
е	0.50 BSC						
e1	0.90	1.10	1.00				
L	0.20	0.40	0.33				
а	0°		8°				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT523



Dimensions	Value (in mm)
С	1.29
X	0.40
X1	0.70
Υ	0.51
Y1	1.80



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